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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Schmitz	Examiner:	Cheung, Lee
Application No.:	10/529,962	Group Art Unit:	2812
Filed:	March 31, 2005	Docket No.:	BE020028 US (VLSI.470PA)
Title:	METHOD OF MANUFACTURING A SEMICONDUCTOR DEVICE WITH A SILICON BODY PROVIDED WITH FIELD ISOLATION REGIONS CONSISTING OF GROOVES FILLED WITH ISOLATING MATERIAL		

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence and the papers, as described hereinabove, are being transmitted via facsimile-transmission to the attention of the Examiner at Commissioner for Patents, MAIL STOP AF, P.O. Box 1450, Alexandria, VA 22313-1450, on Sep 25, 2006.

By: Kelly S. Waltigney

Facsimile No.: 571 273-8300

Kelly S. Waltigney

OFFICE ACTION RESPONSE AFTER FINAL

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Customer No.
24738

Dear Sir:

In response to the Office Action dated August 14, 2006, please reconsider the application in view of the following amendments and remarks.

Amendments to the Claims are reflected in the listing which begins on page 2.

The Remarks section follows on page 5.

Authorization is provided to charge/credit Deposit Account 50-0996
(VLSI.470PA) all required fees/overages to enter this paper.